3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna (AA088) **Engineering Specification** 1. **Product Number** Η 2 4 W 0 4 Η А 0 0 U 1 1 1 2. **Features** *Stable and reliable in performances *Low temperature coefficient of frequency *Low profile, compact size *RoHS 2.0 compliance *SMT processes compatible *AEC-Q200 compliant 3. Applications *GNSS (Global Navigation Satellite System) *Hand-held devices when GPS& BDS & GLONASS & Galileo functions are needed, e.g., PDA, Smart phone, PND. 4. **Description** Unictron's AA088 ceramic chip antenna is designed for GNSS band applications, covering frequencies 1560~1606 MHz. Fabricated with proprietary design and processes, AA088 shows excellent performance and is fully compatible with Star Corp. processes, Arous shows excellent percent percent processes which can decrease the assembly cost and improve device s quality and consistency. ontrol Cent THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES 詠業科技股份有限公司 CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR Unictron Technologies Corporation SALE OF APPARATUS OR DEVICES WITHOUT Technologies Corp. Website:www.unictron.com PERMISSION Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert DOCUMENT REV. TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna

H2U14W1H1A0400 (AA088) Engineering Specification NO. 20



5-2. Electrical Specifications (Evaluation Board Dimensions: 80 x 40 mm²) 5-2-1 Electrical Table

Characteristics		Specifications	Unit
Outline Dimensio	ons	3.2 x 1.6 x 0.5	mm
Ground Plane Di	mensions	80 x 40	mm
Working Frequer	юу	1560~1606	MHz
VSWR (@ center	r frequency)*	2 Max. (typical)	
Characteristic Impedance		50	Ω
Polarization		Linear Polarization	
Peak Gain	(@1575 42MHz)	1.8 (typical**)	dBi
Efficiency		77 (typical**)	%

*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board.. **A typical value is for reference only, not guaranteed.



5-2-2. Frequency vs. V.S.W.R. and Total Radiation Gain

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8-2. Matching circuit :

With the following recommended values of matching and tuning components, the Center frequency will be about 1575.42 MHz at our standard 80 x 40 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.





9. Soldering Conditions

a. Typical Soldering Profile for Lead-free Process



10. Reminders for users of Unictron's chip antennas

- a. Since Unictron's chip antennas are made of ceramic materials which show different rigidity than circuit board materials, bending of circuit board at the locations where chip antennas are mounted may cause the cracking of solder joints or antenna itself.
- b. Any connecting strip which will be cut off at PCB assembly process shall be located away from the installation site of chip antenna. Punching of the connecting strip may cause severe bending of the circuit board and cracking of solder joint or chip antenna itself may occur.
- c. Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.

11. Packing

- (1) Quantity/Reel: 5000 pcs/Reel
- (2) Plastic tape:



b. Tape Dimensions (unit: mm)









h. Reel with label





i. Middle size carton with label



11-2. Process of packing 1 reel includes 5,000pcs(max.) chip antennas Л 1 small size carton includes 2pcs(max.) reels 1 middle size carton includes 5pcs(max.) small catons θ 1 large size carton includes 2pcs(max.) middle cartons 12. Operating & Storage Conditions 12-1. Operating (1) Maximum Input Power: 2 W (2) Operating Temperature: -40°C to 85°C (3) Relative Humidity: 10% to 70% 12-2. Storage (sealed) (1) Storage Temperature: -5°C to 40°C (2) Relative Humidity: 20% to 70% (3) Shelf Life: 1 year Unictron 12-3. Storage (unsealed) Technologies Corp. Meet the criteria of J-STD-033 MSL2a 2020-07-02 Document ontrol Cen THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES 詠業科技股份有限公司 CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR Unictron Technologies Corporation SALE OF APPARATUS OR DEVICES WITHOUT Website:www.unictron.com PERMISSION Prepared by : Jane Designed by : Sam Checked by : Mike Approved by : Herbert DOCUMENT TITLE: 3.2 x 1.6 x 0.5 (mm) GNSS Ceramic Chip Antenna REV. H2U14W1H1A0400

(AA088) Engineering Specification

12-4. Storage (After mounted on customer's PCB with SMT process)

(1) Storage Temperature: -40 $^\circ\!\mathrm{C}$ to 85 $^\circ\!\mathrm{C}$

(2) Relative Humidity: 10% to 70%

13. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.



14. Reliability Test

Test Items	Test Con	ditions			Result		
1. Solderability	*Solder Temperature :	250 ± 5°C					
	*Test time: 2 +/- 0.5 se	С			Pass		
	*With solder paste						
2. Temperature cycling	-40°C/ 30min~90°C /30	Dmin					
	Total <u>100</u> cycles	Total 100 cycles					
	* Specimens are kept a	at standard			Pass		
	measurement environn	nent for mor	e than				
	24 hours before testing	J.					
3. Damp heat	*Humidity:90~95%						
	*Temperature: 85°C	*Temperature: 85°C			Pass		
	*Test time : 240 hours	*Test time : 240 hours					
	* Specimens are kept a	* Specimens are kept at standard					
	measurement environn	nent for mor	e than				
	24 hours before testing	hours before testing					
4 Adhesive strength of	* Resistance to bendin	a of printed-	circuit				
terminal electrodes	test board(110x40x1 6	test board(110x40x1 6mm)					
	* Applied force: 1Kaf :			Pass			
	* Duration : 10+1sec						
E. High tomporature evenesu	*Temperature : 90°C						
3. Tightemperature exposure	*Test duration : 240 bc	NURG					
	* Specimens are kept (nt standard			Pass		
	Specimens are kept at standard						
	24 hours before testing						
	*Tomperature : 40%C	J.					
6. Low temperature exposure	*Temperature · -40°C	Temperature - 40°C					
	* Chaptiments are least at standard			Roop			
	Specimens are kept a	al Stanuaru	a than		1 055		
	measurement environm	nent for mor	e than				
	24 hours before testing).					
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